

NOV 10 2005

Docket No.: 20140-00308-US1
(PATENT)**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:
Cyril Cabral, Jr. et al.

Application No.: 10/714,966

Confirmation No.: 4605

Filed: November 18, 2003

Art Unit: 2811

For: ELECTROPLATED COWP COMPOSITES
STRUCTURES AS COPPER BARRIER
LAYERS

Examiner: H. K. Vu

SUPPLEMENTAL AMENDMENT IN RESPONSE TO FINAL OFFICE ACTION

Box AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated June 15, 2005 and the Advisory Actions dated September 6, 2005 and November 4, 2005, please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.